PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yuji Yasui	05/14/2008
Ikue Kawasumi	05/14/2008

RECEIVING PARTY DATA

Name:	Honda Motor Co., Ltd.	
Street Address:	1-1, Minami-Aoyama	
Internal Address:	2-chome	
City:	Minato-ku, Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12134670

CORRESPONDENCE DATA

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NAME OF SUBMITTED: Authory A. Laurentone

NAME OF SUBMITTER:

Anthony A. Laurentano

Total Attachments: 1

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PATENT REEL: 021307 FRAME: 0282

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\$40.00

ASSIGNMENT

I (We), Yuji YASUI and Ikuc KAWASUMI, of c/o HONDA R&D CO., LTD. 4-1, Chuo 1-Chome, Wako-shi, Saitama, 351-0193 Japan, in consideration of One Dollar and other valuable consideration paid to me by

HONDA MOTOR CO., LTD.

a corporation of <u>JAPAN</u>, having its principal place of business at <u>1-1</u>, <u>Minami-Aoyama 2-chome</u>, <u>Minato-ku</u>, <u>Tokyo</u>, <u>Japan</u>, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

HONDA MOTOR CO., LTD.

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

Property in a certain invention or improvement in
described in an application are executed by us of even date herewith and about to be filed
Serial No. 12/134670 , filed on June 6, 2008
in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And I agree, for myself and my executors and administrators, with said corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said corporation, with specifications and claims in such form as shall be approved by the counsel of said corporation and to vest and confirm in said corporation, its successors and assigns, the legal title to all such patents.
And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications
based thereon to said corporation, its successors and assigns.
By:Yuji Zasui
Name: Yuji YASUI
Date: May 14, 2008
By: Ikue Kawasumi
Name: Ikue KAWASUMI
Date: May 14, 2008

RECORDED: 07/29/2008

PATENT REEL: 021307 FRAME: 0283